

Product Change Notification

Change Notification #: 116995 - 00

Change Title: Select Intel® OptaneTM SSD 900P Series

and Intel® OptaneTM SSD 905P Series

SKUs, PCN 116995-00, Label,

Label Update

Date of Publication: July 2, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: July 24, 2019

Description of Change to the Customer:

The Intel® Optane™ SSD 900P Series and Intel® Optane™ SSD 905P Series SKUs listed in the Products Affected Table below will have the following change.

Remove ISN Label assembly.

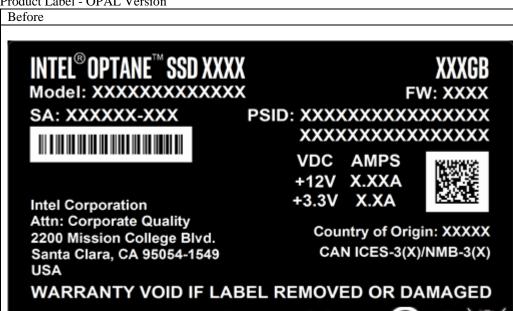




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The product labels will be updated to include an ISN# and barcode. See example labels below.

Product Label - OPAL Version



After



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SA: XXXXXXXXXXX



Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd.

Santa Clara, CA 95054-1549 USA

VDC AMPS +12V X.XXA +3.3V X.XA



XXXGB

FW: XXXX

Country of Origin: XXXXX CAN ICES-3(X)/NMB-3(X)

WARRANTY VOID IF LABEL REMOVED OR DAMAGED















After

INTEL®OPTANE™ SSD XXXX

Model: XXXXXXXXXXXXX

SA: XXXXXXX-XXX



ISN: VSPPYWWDXXXXNNNFGN

Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd.

Santa Clara, CA 95054-1549

USA



VDC AMPS +12V X.XXA +3.3V X.XA



XXXGB

FW: XXXX

Country of Origin: XXXXX CAN ICES-3(X)/NMB-3(X)

WARRANTY VOID IF LABEL REMOVED OR DAMAGED















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Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is only to the labels used on the product.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	TA	SA
Intel® Optane TM SSD 900P Series (280GB, 1/2 Height	SSDPED1D280GAX1	945760	H93319-304	H93321-304
PCIe x4, 3D XPoint™) Reseller Single Pack				
Intel® Optane TM SSD 900P Series (480GB, 1/2 Height	SSDPED1D480GAX1	945761	H93320-304	H93324-304
PCIe x4, 3D XPoint™) Reseller Single Pack				
Intel® Optane TM SSD 905P Series (960GB, 1/2 Height	SSDPED1D960GAX1	945762	J60240-303	J60246-303
PCIe x4, 3D XPoint™) Reseller Single Pack				
Intel® Optane TM SSD 905P Series (1.5TB, 1/2 Height	SSDPED1D015TAX1	945763	J60241-302	J60247-302
PCIe x4, 3D XPoint™) Reseller Single Pack				
Intel® Optane TM SSD 900P Series (280GB, ½ Height PCIe	SSDPED1D280GASX	962752	J78489-304	H93321-304
3.0 X4, 20nm 3D XPoint TM)				
Intel® Optane TM SSD 900P Series (480GB, ½ Height PCIe	SSDPED1D480GASX	962754	J78490-304	H93324-304
3.0 X4, 20nm 3D XPoint TM)				

PCN Revision History:

Date of Revision: Revision Number: Reason:

July 2, 2019 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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